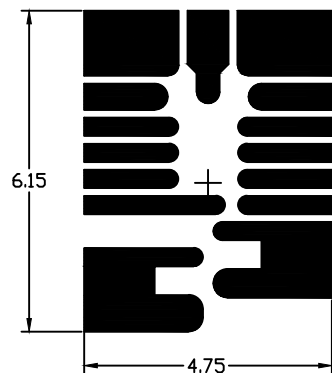
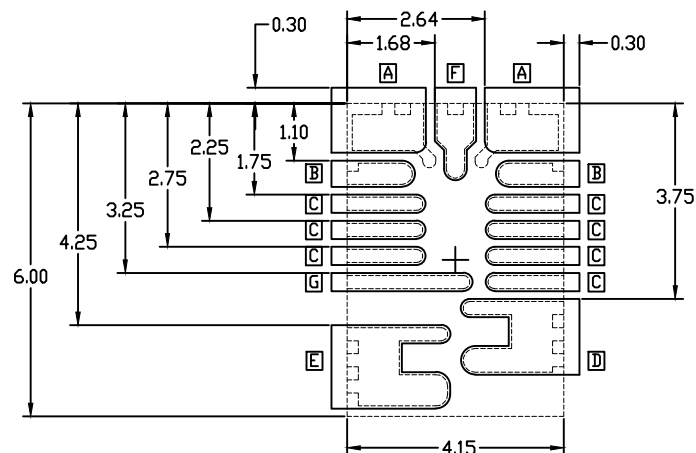


RECOMMENDED LAND PATTERN



PAD TYPE	RECOMMENDED PCB PAD
A	
B	

PACKAGE OVERLAY



PAD TYPE	RECOMMENDED PCB PAD
C	
D	

PAD TYPE	RECOMMENDED PCB PAD
E	
F	
G	

NOTES:

1. REFERENCE PKG. OUTLINE: 21-100020
2. LAND PATTERN COMPLIES TO: IPC7351A.
3. ALL DIMENSIONS APPLY TO PbfREE (+) PKG. CODE ONLY.
4. ALL DIMENSIONS IN MM.
5. REFER TO APPLICATION NOTES 5963 FOR SMT STENCIL DESIGN RECOMMENDATIONS

—DRAWING NOT TO SCALE—

This document (including dimensions, notes & specs) is a recommendation based on typical circuit board manufacturing parameters. Since land pattern design depend on many factors unknown to Maxim (eg. user's board manufacturing specs), user must determine suitability for use. This document is subject to change without notice. Contact technical support at <http://www.maxim-ic.com/support> for further questions.



TITLE:
PACKAGE LAND PATTERN, [P154A6F+1]
15L FCQFN 4.15x6x0.95mm

APPROVAL
JIE MAD

DOCUMENT CONTROL NO.
90-100021

REV. **E** 1/1